

PCN#20191010001.1 Qualification of new Bump site and BOM for select devices

Change Notification / Sample Request

Date: October 10, 2019 To: Newark/Farnell PCN

Dear Customer:

This is an announcement of a change to a device that is currently offered by Texas Instruments. The details of this change are on the following pages.

We request you acknowledge receipt of this notification within **30** days of the date of this notice. Lack of acknowledgement of this notice within 30 days constitutes acceptance of the change. If you require samples or additional data to support your evaluation, please request within 30 days.

The proposed first ship date is indicated on page 3 of this notification, unless customer agreement has been reached on an earlier implementation of the change.

This notice does not change the end-of-life status of any product. Should product affected be on a previously issued product withdrawal/discontinuance notice, this notification does not extend the life of that product or change the life time buy offering/discontinuance plan.

For questions regarding this notice, contact your local Field Sales Representative or the PCN Team (<u>PCN ww admin team@list.ti.com</u>). For sample requests or sample related questions, contact your field sales representative.

Sincerely,

PCN Team SC Business Services

20191010001.1 Attachment: 1

Products Affected:

The devices listed on this page are a subset of the complete list of affected devices. According to our records, these are the devices that you have purchased within the past twenty-four (24) months. The corresponding customer part number is also listed, if available.

DEVICE

CUSTOMER PART NUMBER

ADS7886SBDBVT	null
ADS7883SBDBVT	null
ADS7883SDBVT	null
ADS7885SDBVT	null
ADS7886SDBVT	null
ADS7887SDBVT	null
ADS8319IBDGST	null
ADS8319IDGST	null
ADS8339IDGST	null

Technical details of this Product Change follow on the next page(s).

										·	
PC	Number:	20191010	0001.1				Ρ	CN Da	ate:	Oct 10 2)19
Titl	Title: Qualification of new Bump site and BOM for select devices										
Cus	Customer Contact: PCN Manager Dept: Quality Services										
Pro	posed 1 st Sh	ip Date:	Jan 10 2	020	Est	timateo Ava		-		provided a	t
Cha	Change Type: Availability: sample request										
	Assembly Sit	e		Design			\boxtimes	Wafer	· Bum	p Site	
	Assembly Pro			Data S	heet		\square	Wafer	Bum	p Material	
\boxtimes	Assembly Ma	terials		Part nu	mber change	e	\boxtimes	Wafer	Bum	p Process	
	Mechanical S	pecification		Test Si	te			Wafer	Fab S	Site	
	Packing/Ship	ping/Labeli	ng	Test Pr	ocess			Wafer	Fab I	Materials	
								Wafer	Fab F	Process	
				PCN	Details						
Des	scription of C	Change:									
sect	section below as follows: What Current New										
			What			Cı	ırrer	nt		New	٦
							irrer AT5	ıt		New JCAP	
		Βι	What Imp Site Composit	ion			-	-	C		_
		Bump	Imp Site	ion		ŀ	AT5	-	C	JCAP	-
	Lead finish	Bı Bump D	ımp Site Composit vie Coat		rices only)	H N	AT5 Hi Pb			JCAP u/AgSn	
		Bı Bump D	ımp Site Composit vie Coat		rices only)	H N	AT5 Hi Pb None iPdAu	u	M	JCAP u/AgSn PI	
Rea		Bump D (ADS7883	Imp Site Composit ie Coat 3/4/5, &		rices only)	H M	AT5 Hi Pb None iPdAu	u	M	JCAP u/AgSn PI latte Sn	
	Lead finish	Bump D (ADS7883	Imp Site Composit ie Coat 3/4/5, &		vices only)	H M	AT5 Hi Pb None iPdAu	u	M	JCAP u/AgSn PI latte Sn	
Con	Lead finish	Bump D (ADS7883 nge: ply	Imp Site Composit ie Coat 3/4/5, & ECAT	DGS dev		H N E3, (AT5 Hi Pb None iPdAu G4 oi	u r E4	M	JCAP u/AgSn PI latte Sn i3 or G4	
Con	Lead finish ason for Char tinuity of Sup icipated imp	Bump D (ADS7883 nge: ply	Imp Site Composit ie Coat 3/4/5, & ECAT	DGS dev		H N E3, (AT5 Hi Pb None iPdAu G4 oi	u r E4	M	JCAP u/AgSn PI latte Sn i3 or G4	
Con Ant Non	Lead finish ason for Char tinuity of Sup icipated imp	Bump D (ADS7883 nge: ply act on For	imp Site Composit ie Coat 3/4/5, & ECAT m, Fit, Fu	DGS dev	Quality or F	H N E3, (AT5 Hi Pb None iPdAu G4 oi	u r E4	M	JCAP u/AgSn PI latte Sn i3 or G4	

 obtained from the <u>TI ECO website</u>.

 Changes to product identification resulting from this PCN:

None

Product Affected:							
AD	S7883SBDBVR	ADS7886SBDCKR	ADS7888SDBVR	ADS8318IDRCTG4			
AD	S7883SBDBVT	ADS7886SBDCKT	ADS7888SDBVT	ADS8319IBDGSR			
AD	S7883SDBVR	ADS7886SDBVR	ADS7888SDCKR	ADS8319IBDGST			
AD	S7883SDBVT	ADS7886SDBVT	ADS7888SDCKT	ADS8319IBDRCR			
AD	S7884SDBVR	ADS7886SDCKR	ADS8318IBDGSR	ADS8319IBDRCT			

ſ	ADS7884SDBVT	ADS7886SDCKT	ADS8318IBDGST	ADS8319IDGSR
	ADS7885SDBVR	ADS7887SDBVR	ADS8318IBDRCT	ADS8319IDGST
	ADS7885SDBVT	ADS7887SDBVT	ADS8318IDGSR	ADS8319IDRCT
	ADS7886SBDBVR	ADS7887SDCKR	ADS8318IDGST	ADS8339IDGSR
	ADS7886SBDBVT	ADS7887SDCKT	ADS8318IDRCT	ADS8339IDGST



TI Information Selective Disclosure

Qualification Results Data Displayed as: Number of lots / Total sample size / Total failed

Туре	Test Name / Condition	Duration	Qual Device: ADS7886SBDBVR	Qual Device: AD\$7886\$DCKR	Qual Device: ADS8318IBDGSR	QBS Process Reference: <u>OPA300AID</u>
AC	Autoclave 121C	96 Hours	-	-	-	3/231/0
CDM	ESD CDM	1000 V	-	-	-	1/3/0
ED	Electrical Characterization	Per Datasheet Parameters	Pass	-	Pass	Pass
HAST	Biased HAST, 110C/85%RH	264 Hours	1/77/0	1/77/0		-
HAST	Biased HAST, 130C/85%RH	96 Hours	-	-	1/77/0	3/231/0
HBM	ESD HBM	4000 V	-	-	-	1/3/0
HTOL	Life Test, 150C	300 Hours	-	-	-	3/231/0
HTSL	High Temp Storage Bake 150C	1000 Hours	-	-	-	3/135/0
HTSL	High Temp Storage Bake 170C	420 Hours	1/77/0	1/77/0	3/231/0	-
LU	Latch-up	(per JESD78)	-	-	-	1/12/0
TC	Temperature Cycle, -65/150C	500 Cycles	2/154/0	2/154/0	3/231/0	3/231/0
UHAST	Unbiased HAST 130C/85%RH	96 Hours	1/77/0	1/77/0	3/231/0	-
YLD	Yield Analysis	-	Pass	Pass	Pass	-

 VLD
 Yield Analysis
 Pass
 Pass
 Pass

 - Preconditioning was performed for Autoclave, Unbiased HAST, THB/BiasedHAST, Temperature Cycle, Thermal Shock, and HTSL, as applicable

 - The following are equivalent HTOL options based on activation energy of 0.7eV : 125C/1k Hours, 140C/480 Hours, 150C/300 Hours, and 155C/240 Hours

 - The following are equivalent HTSL options based on activation energy of 0.7eV : 125C/1k Hours, and 170C/420 Hours

 - The following are equivalent HTSL options based on activation energy of 0.7eV : 150C/1k Hours, and 170C/420 Hours

 - The following are equivalent TTSL options based on activation energy of 0.7eV : 150C/1k Hours, and 170C/420 Hours

 - The following are equivalent TTSL options based on activation energy of 0.7eV : 150C/1k Hours, and 170C/420 Hours

 - The following are equivalent TTSL options based on activation energy of 0.7eV : 150C/1k Hours, and 170C/420 Hours

 - The following are equivalent TTSL options based on activation energy of 0.7eV : 150C/1k Hours, and 170C/420 Hours

 - The following are equivalent TTSL options based on activation energy of 0.7eV : 150C/1k Hours, and 170C/420 Hours

 - The following are equivalent TTSL options based on activation energy of 0.7eV : 150C/1b Cycles and -65C/150C/500 Cycles

 Quality and Environmental data is available at TI's external Web site: http://www.ti.com/

 Green/Pb-free (SMT) and Green

Change Number: C1806171 TI Qualification ID: 20180626-126214

Texas Instruments Incorporated



Туре	Test Name / Condition	Duration	Qual Device: ADS8318IBDRCT	QBS Product Reference: <u>ADS8318DGS</u>	QBS Product Reference: <u>ADS8318DRC</u>	QBS Process Reference: <u>OPA300AID</u>
AC	Autoclave 121C	96 Hours	-	3/231/0	3/231/0	3/231/0
CDM	ESD - CDM	1500 V	-	1/3/0	1/3/0	-
CDM	ESD CDM	1000 V	-	-	-	1/3/0
ED	Electrical Characterization	Per Datasheet Parameters	Pass	Pass	Pass	Pass
HAST	Biased HAST, 130C/85%RH	96 Hours	-	1/77/0	3/231/0	3/231/0
HBM	ESD - HBM	2500 V	-	-	1/3/0	1/3/0
HTOL	High Temp Operating Life, 155C	240 Hours	-	1/115/0	3/343/0	-
HTOL	Life Test, 150C	300 Hours	-	-	-	3/231/0
HTSL	High Temp Storage Bake 150C	1000 Hours	-	-	-	3/135/0
HTSL	High Temp Storage Bake 170C	420 Hours	3/228/0	3/231/0	3/231/0	-
LU	Latch-up	(per JESD78)	-	-	-	1/12/0
тс	Temperature Cycle - 65/150C	500 Cycles	3/231/0	-	-	3/231/0
UHAST	Unbiased HAST 130C/85%RH	96 Hours	3/231/0	-	-	-

Qualification Results Data Displayed as: Number of lots / Total sample size / Total failed

Preconditioning was performed for Autoclave, Unbiased HAST, THB/Biased HAST, Temperature Cycle, Thermal Shock, and HTSL, as applicable
 The following are equivalent HTOL options based on an activation energy of 0.7eV: 125C/1k Hours, 140C/480 Hours, 150C/300 Hours, and 155C/240 Hours
 The following are equivalent HTSL options based on an activation energy of 0.7eV: 150C/1k Hours, and 170C/420 Hours

The following are equivalent HTSL options based on an activation energy of 0.7eV : 150C/1% Hours, and 170C/420 Hours
 The following are equivalent Temp Cycle options per JESD47 :-55C/125C/700 Cycles and -65C/150C/500 Cycles

Quality and Environmental data is available at TI's external Web site: http://www.ti.com/

Green/Pb-free Status:

Qualified Pb-Free(SMT) and Green

For questions regarding this notice, e-mails can be sent to the contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
WW PCN Team	PCN_ww_admin_team@list.ti.com

IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATASHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring

your application meets applicable standards, and any other safety, security, or other requirements. These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to TI's Terms of Sale (www.ti.com/legal/termsofsale.html) or other applicable terms available either on ti.com or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products.